

## **FEATURES**

| 36 Watts Peak Pulse Power per Line (tp=8/20µs)

Response Time is Typically < 1 ns

Low leakage current

Low clamping voltage

## **APPLICATIONS**

| Smartphones, tablet computers

Blu-ray and DVD recorders and players

Video equipment and accessories



DFN0603



## **IEC COMPATIBILITY**

| IEC61000-4-2 (ESD) ±20kV (air), ±20kV (contact) | IEC61000-4-4 (EFT) 40A (5/50ns)

## **APPROVALS**

RoHS | Compliance with 2011/65/EU | HF | Compliance with IEC61249-2-21:2003



## THERMAL CONSIDERATIONS

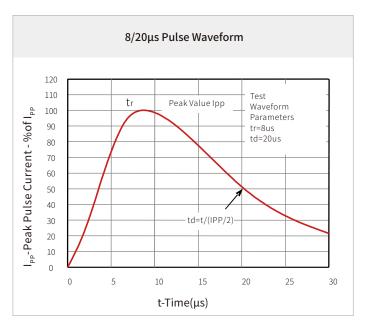
Symbol	Parameter	Value	Unit
$P_{pp}$	Peak Pulse Power (tp=8/20μs waveform)	36	Watts
$T_{J}$	Operating Temperature Range	-40 to +85	°C
$T_{stg}$	Storage Temperature Range	-55 to +150	°C

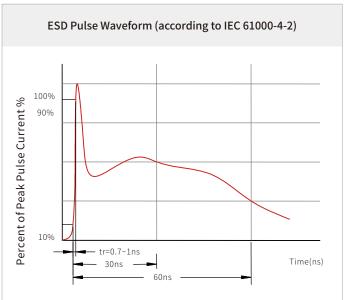
# **ELECTRICAL CHARACTERISTICS**

Symbol	Parameter	Condition	Min.	Тур.	Max.	Unit
$V_{_{\mathrm{RWM}}}$	Reverse Stand-offVoltage				5.0	V
$V_{_{BR}}$	Reverse Breakdown Voltage	I <sub>τ</sub> =1mA	5.6			V
I <sub>R</sub>	Reverse Leakage Current	V <sub>RWM</sub> =5V			100	nA
V <sub>c</sub>	Clamping Voltage	I <sub>pp</sub> =3A,tp=8/20μs			12	V
l <sub>pp</sub>	Peak Pulse Current	tp=8/20μs			3	А
C	Off State Junction Capacitance	V <sub>R</sub> =0V, f=1MHz		3.5	5	pF



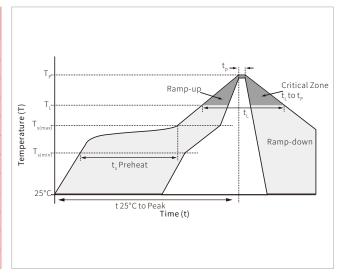
# **CHARACTERISTIC CURVES**





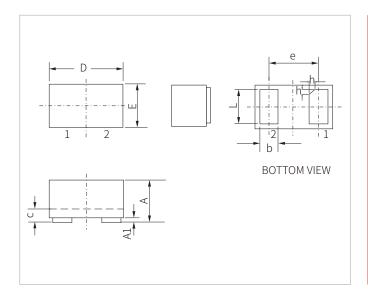
# **SOLDERING PARAMETERS**

	Reflow Condition	Lead-free assembly	
	Temperature Max (T <sub>s(min)</sub> )	150°C	
Pre Heat	Temperature Max (T <sub>s(max)</sub> )	200°C	
	Time (min to max) (t <sub>s</sub> )	60 – 180 secs	
Average ran	Average ramp up rate (Liquidus Temp (T <sub>L</sub> ) to peak		
	3°C/second max		
Reflow	Temperature (T <sub>L</sub> ) (Liquidus)	217°C	
Kellow	Time (min to max) $(t_L)$	60 – 150 seconds	
Peak Temp	260°C		
Time within	20 – 40 seconds		
Ramp-dow	6°C/second max		
Time 25°C to peak Temperature (T <sub>P</sub> )		8 minutes max.	
Do not exce	260°C		



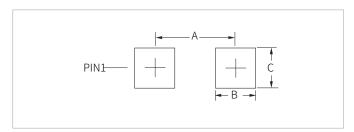


# **DFN0603 PACKAGE INFORMATION**



Ref.	Millimeters		Inches		
KCI.	Min.	Max.	Min.	Max.	
А	0.28	0.36	0.011	0.014	
A1	0	0.05	0	0.002	
b	0.13	0.24	0.005	0.009	
С	0.05	0.15	0.002	0.006	
D	0.55	0.70	0.022	0.028	
е	0.35	0.35BSC		4BSC	
E	0.25	0.35	0.010	0.014	
L	0.20	0.30	0.008	0.012	
h	0	0.10	0	0.004	

# **RECOMMENDED PAD LAYOUT DIMENSIONS**



Ref.	Millimeters	Inches
А	0.38	0.015
В	0.23	0.009
С	0.30	0.012

# **ORDERING INFORMATION**

Part Number	Component Package	QTY/Reel	Reel Size
SE06F04B5.0LA	DFN0603	10000PCS	7"



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### By QR Code





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